

PRESS RELEASE

Besi Announces 2013 Third Quarter Results Release, Conference Call and Webcast Date

Duiven, the Netherlands, October 23, 2013 - BE Semiconductor Industries N.V. ("the Company" or "Beside") (Euronext: BESI; OTCQX: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will release results for the third quarter ended September 30, 2013, on Thursday, October 31, 2013 at 7.00 a.m. Central European Time (2.00 a.m. New York time).

Besi will host a conference call and audio webcast (log on via www.besi.com) to discuss its results for the third quarter ended September 30, 2013, on Thursday, October 31, 2013 at 4.00 p.m. Central European Time (11.00 a.m. New York time). The teleconference dial-in number is (31) 20 531 5869. The audio webcast will remain available on www.besi.com.

About Beside

Besi is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, computer, automotive, industrial, RFID, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Beside's ordinary shares are listed on NYSE Euronext Amsterdam (symbol: BESI) and OTCQX International (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website: www.besi.com.

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